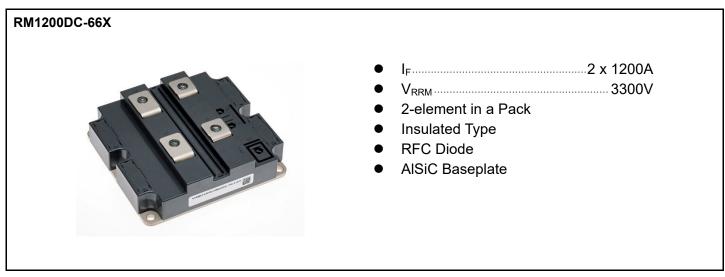


< HIGH VOLTAGE DIODE MODULES >

RM1200DC-66X

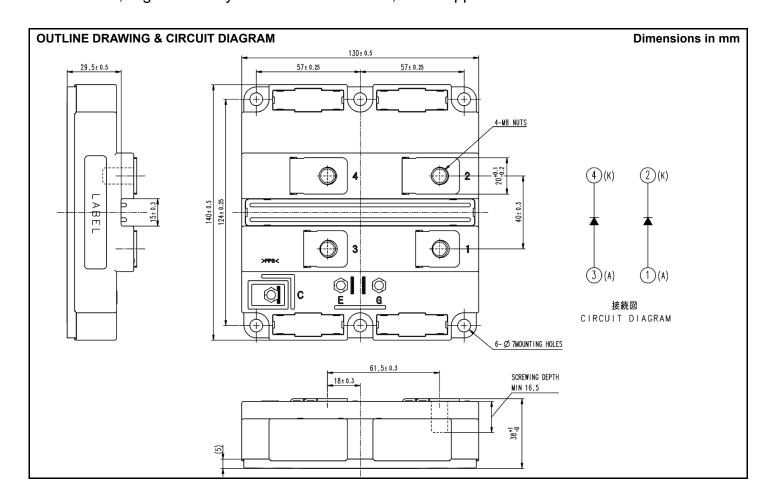
HIGH POWER SWITCHING USE INSULATED TYPE

High Voltage Diode Modules



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



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HIGH POWER SWITCHING USE

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MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V_{RRM}	Repetitive peak reverse voltage	$T_j = -40+150$ °C	3300	V
		$T_j = -50$ °C	3200	V
I _F	Forward current	DC, $T_c = 90$ °C	1200	Α
I _{FRM}	Forward current	Pulse (Note 1)	2400	Α
I _{FSM}	Surge (non-repetitive) forward current	T = 150°C + = 10 mg Last sing ways \(\sigma = 0.\)	10.6	kA
I ² t	Surge current load integral	T_{j_start} = 150°C, t_p = 10 ms, Half-sine wave, V_R = 0 V	561	kA ² s
P _{tot}	Maximum power dissipation	T _c = 25°C	7500	W
V _{iso}	Isolation voltage	RMS, sinusoidal, f = 60 Hz, t = 1 min.	6000	V
V _e	Partial discharge extinction voltage	RMS, sinusoidal, f = 60 Hz, Q _{PD} ≤ 10 pC	2600	V
T _i	Junction temperature		−50 ~ +150	°C
T _{jop}	Operating junction temperature		−50 ~ +150	°C
T _{stg}	Storage temperature		−55 ~ +150	°C

ELECTRICAL CHARACTERISTICS

Comple at	Item	Conditions		Limits			Llmit
Symbol	item	Conditions	Conditions		Тур	Max	Unit
			T _j = 25°C	_	_	2.0	
I _{RRM}	Repetitive reverse current	$V_{RM} = V_{RRM}$	T _i = 125°C	_	2.0	_	mA
			T _j = 150°C	_	_	24.0	
.,			T _j = 25°C	_	2.20	_	
V_{FM}	Forward voltage (Note 1)	I _F = 1200 A	T _i = 125°C	_	2.40	_	V
(Chip)			T _i = 150°C		2.50	3.00	
		I _F = 1200 A	T _j = 25°C	_	2.50		
V_{FM}	Forward voltage (Note 1)		T _i = 125°C	_	2.80	_	
(Terminal)			T _i = 150°C		2.95		
	Reverse recovery time		$T_j = 25^{\circ}C$	_	0.95	_	
t _{rr}			T _j = 125°C	_	1.10	_	μs
			T _i = 150°C	_	1.15	_	
	Reverse recovery current		$T_j = 25^{\circ}C$	_	1800	_	А
I _{rr}		V_{CC} = 1800V I_F = 1200 A @ T_j = 25°C 3950 A/µs @ T_j = 125°C 3900 A/µs @ T_j = 150°C L_s = 150 nH Inductive load	T _j = 125°C	_	1550	_	
			T _j = 150°C		1650		
	Reverse recovery charge (Note 2)		$T_j = 25^{\circ}C$	_	1050	_	μC
Q _{rr(10%)}			T _j = 125°C	_	1600	_	
			T _j = 150°C	_	1650	_	
	Reverse recovery charge		$T_j = 25^{\circ}C$	_	1200	_	
Q_{rr}			T _j = 125°C	_	1750	_	μC
			T _j = 150°C	_	1800	_	
	Reverse recovery energy per pulse (Note 3)		$T_j = 25^{\circ}C$	_	1.15	_	
E _{rec(10%)}			T _j = 125°C	_	1.65	_	J
			T _j = 150°C	_	1.85	_	
	Reverse recovery energy per pulse		T _j = 25°C	_	1.25	_	
E _{rec}			T _j = 125°C	_	1.75	_	J
			T _j = 150°C	_	1.95	_	

< HIGH VOLTAGE DIODE MODULES >

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HIGH POWER SWITCHING USE

INSULATED TYPE

High Voltage Diode Modules

THERMAL CHARACTERISTICS

Cumbal	lka na	Conditions	Limits			I Imit
Symbol	ool Item Conditions		Min	Тур	Max	Unit
R _{th(j-c)}	Thermal resistance	Junction to Case (per 1/2 module)		_	16.5	K/kW
R _{th(c-s)}	Contact thermal resistance	Case to heat sink, λ_{grease} = 1 W/m K $D_{(c-s)}$ = 80 μ m (per 1/2 module)		15.0	_	K/kW

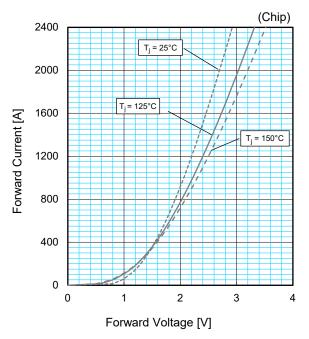
MECHANICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Linit
			Min	Тур	Max	Unit
M_t	NAtim A	M8 : Main terminals screw	7.0	_	19.0	N⋅m
M_s	Mounting torque	M6 : Mounting screw	3.0	_	6.0	N·m
m	Mass		_	0.9	_	kg
CTI	Comparative tracking index		600	_	_	_
d _a	Clearance		19.5	_	_	mm
ds	Creepage distance		32.0	_	_	mm
L _{PAK}	Parasitic stray inductance	1/2 module	_	24.0	_	nΗ
R _{AA'+KK'}	Internal lead resistance	$T_c = 25$ °C, 1/2 module	_	0.27	_	mΩ

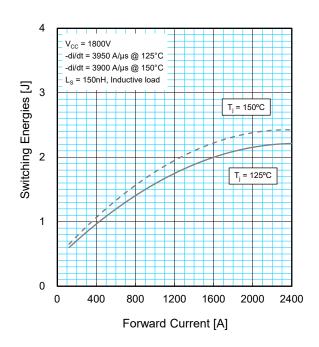
Note 1. Pulse width and repetition rate should be such as to cause negligible temperature rise. Note 2. $Q_{rr(10\%)}$ is the integral of $I_{rr} \times$ dt ($t(0AI_F)$ - $t(-0.1I_F)$). Note 3. The integration range of switching energies is from $E_{rec(10\%)}$ is from $10\%V_R$ to $10\%I_F$.

PERFORMANCE CURVES

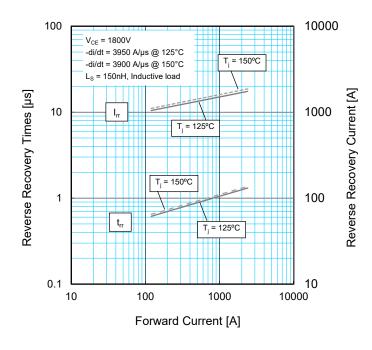
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



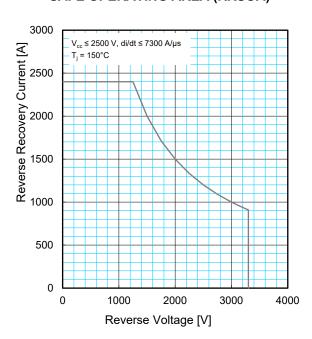
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)

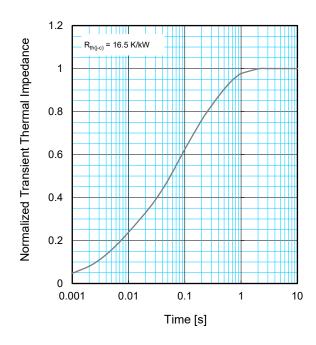


FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



PERFORMANCE CURVES

TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - \exp\left(-\frac{t}{\tau_{i}}\right) \right\}$$

	1	2	3	4
R _i / R _{th(j-c)} :	0.0096	0.1893	0.4044	0.3967
τ _i [sec]:	0.0001	0.0058	0.0602	0.3512

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High Voltage Diode Modules

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HIGH POWER SWITCHING USE

INSULATED TYPE

High Voltage Diode Modules

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